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IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications. Offering both low on-state voltage and minimal switching loss, the IGBT is well suited for resonant or soft switching applications. Incorporated into the device is a rugged co-packaged free wheeling diode with a low forward voltage.

Features

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- Low Gate Charge
- 5 µs Short–Circuit Capability
- These are Pb–Free Devices

Typical Applications

- Inverter Welding Machines
- Microwave Ovens
- Industrial Switching
- Motor Control Inverter

ABSOLUTE MAXIMUM RATINGS

Deting	Symphol	Value	Unit
Rating	Symbol	value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	80 40	A
Pulsed collector current, T_{pulse} limited by T_{Jmax}	I _{CM}	320	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	Ι _F	80 40	A
Diode pulsed current, T_{pulse} limited by $T_{J\text{max}}$	I _{FM}	320	A
Gate-emitter voltage	V _{GE}	±20	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	260 104	W
Short–Circuit Withstand Time V_{GE} = 15 V, V_{CE} = 600 V, T_J \leq 150°C	T _{sc}	5	μs
Operating junction temperature range	TJ	–55 to +150	°C
Storage temperature range	T _{stg}	–55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C
		260	°C

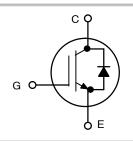
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

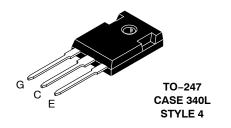


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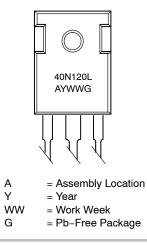
http://onsemi.com

40 A, 1200 V V_{CEsat} = 1.90 V E_{off} = 1.40 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB40N120LWG	TO-247 (Pb-Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.48	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.5	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 µA	V _{(BR)CES}	1200	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 40 A V_{GE} = 15 V, I _C = 25 A, T _J = 150°C	V _{CEsat}	1.45 _	1.90 2.1	2.35 _	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 400 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$\label{eq:VGE} \begin{array}{l} V_{GE} = 0 \ V, \ V_{CE} = 1200 \ V \\ V_{GE} = 0 \ V, \ V_{CE} = 1200 \ V, \ T_{J} = 150^{\circ} C \end{array}$	I _{CES}	-		0.5 2.0	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V, V_{CE} = 0 V	I _{GES}	_	-	200	nA
DYNAMIC CHARACTERISTIC	•					
Input capacitance		C _{ies}	-	10,400	-	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	245	-	
Reverse transfer capacitance		C _{res}	-	185	-	
Gate charge total	V _{CE} = 600 V, I _C = 40 A, V _{GE} = 15 V	Qg	-	420	-	nC
Gate to emitter charge		Q _{ge}	-	95	-	
Gate to collector charge		Q _{gc}	-	178	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	_	140	_	
Rise time		t _r	-	40	-	
Turn-off delay time	$T_{J} = 25^{\circ}C$ $V_{CC} = 600 \text{ V}, I_{C} = 40 \text{ A}$	t _{d(off)}	-	360	-	ns
Fall time	R _g = 10 Ω V _{GE} = 0 V/ 15 V	t _f	-	132	-	
Turn-on switching loss	$V_{GE} = 0.07 + 3.0$	Eon	-	5.5	-	ml
Turn-off switching loss	1	E _{off}	-	1.40	-	mJ
Turn-on delay time		t _{d(on)}	-	134	_	
Rise time	$T_{J} = 125^{\circ}C$ $V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 0 \text{ V}/ 15 \text{ V}$	t _r	-	44	-	
Turn-off delay time		t _{d(off)}	-	380	-	ns
Fall time		t _f	-	185	-	
Turn-on switching loss		E _{on}	-	6.8	-	ml
Turn-off switching loss	<u>]</u>	E _{off}	-	2.6	-	mJ
DIODE CHARACTERISTIC						
Forward voltage	V _{GE} = 0 V, I _F = 40 A V _{GE} = 0 V, I _F = 40 A, T _J = 150°C	V _F	-	1.6 1.8	1.8 _	V

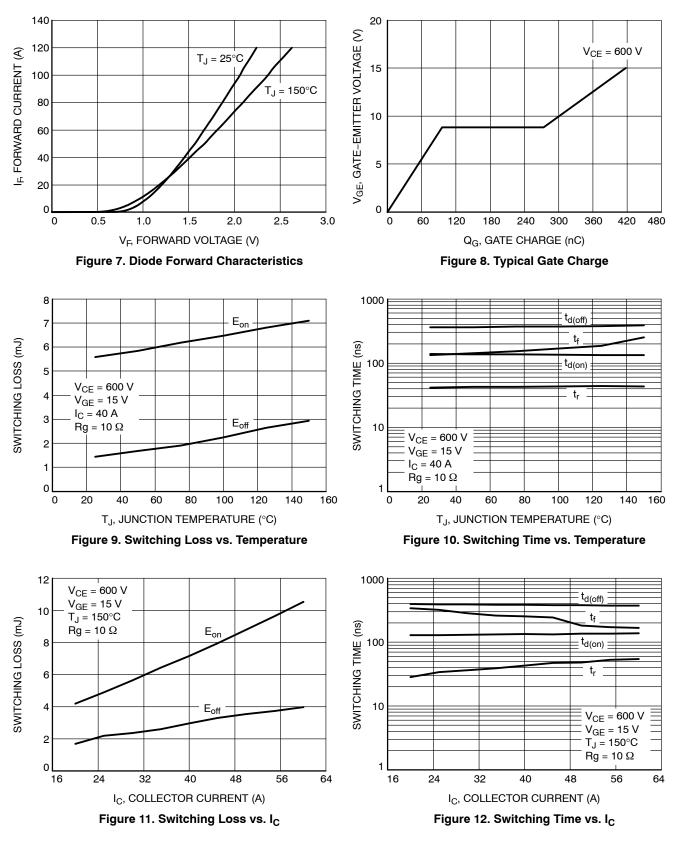
160 140 V_{GE} = 20 to 13 V V_{GE} = 20 to 11 V $T_J = 150^{\circ}C$ T_{.1} = 25°C 140 Ic, COLLECTOR CURRENT (A) ₹ 120 10 V COLLECTOR CURRENT 10 V 120 100 100 80 9 V 80 60 9 V 60 40 8 V 40 Ö 20 20 8 V 7 V 7 V 0 0 2 з 4 5 0 2 3 5 0 1 4 V_{CE}, COLLECTOR-EMITTER VOLTAGE (V) V_{CE}, COLLECTOR-EMITTER VOLTAGE (V) **Figure 1. Output Characteristics** Figure 2. Output Characteristics 160 160 V_{GE} = 20 to 11 V 140 140 Ic, COLLECTOR CURRENT (A) Ic, COLLECTOR CURRENT (A) 10 V $T_J = -40^{\circ}C$ 120 120 100 100 80 80 60 60 T_J = 150°C 9 V 40 40 T_{.1} = 25°C 7 V 20 20 8 V 0 0 0 4 12 2 3 4 5 8 0 1 V_{CE}, COLLECTOR-EMITTER VOLTAGE (V) V_{GE}, GATE-EMITTER VOLTAGE (V) **Figure 3. Output Characteristics Figure 4. Typical Transfer Characteristics** V_{CE}, COLLECTOR-EMITTER VOLTAGE (V) 100,000 3.5 I_C = 80 A 3.0 Cies 10,000 2.5 I_C = 40 A CAPACITANCE (pF) 2.0 1000 I_C = 10 A 1.5 Coe 1.0 $I_C = 5 A$ 100 Cres 0.5 0 10 40 70 20 80 100 120 140 160 180 200 -50 -20 10 100 130 160 0 40 60 TJ, JUNCTION TEMPERATURE (°C) V_{CE}, COLLECTOR-EMITTER VOLTAGE (V)

TYPICAL CHARACTERISTICS

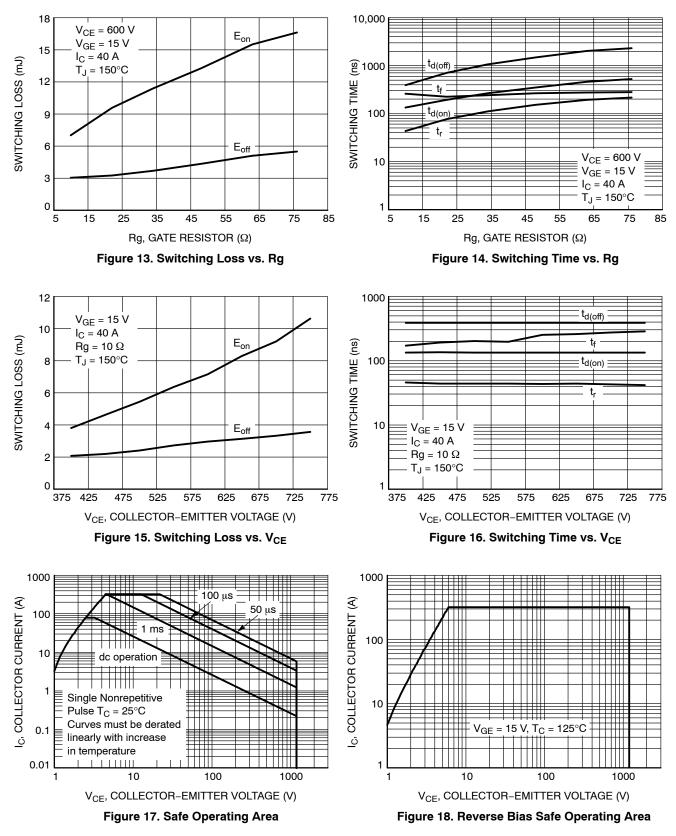
Figure 6. Typical Capacitance

Figure 5. V_{CE(sat)} vs. T_J

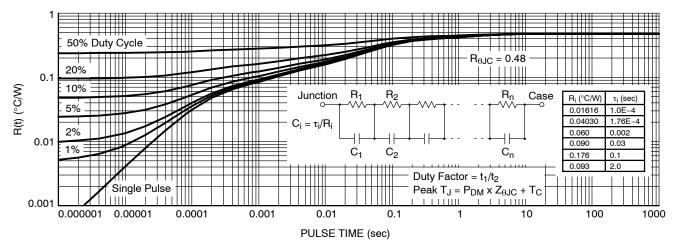
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





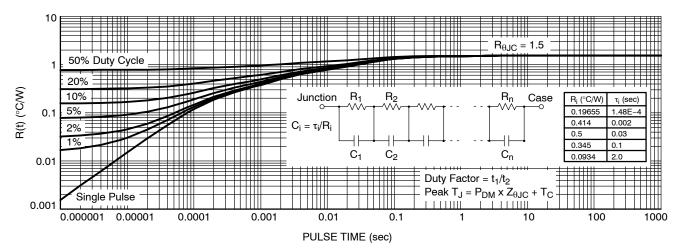


Figure 20. Diode Transient Thermal Impedance

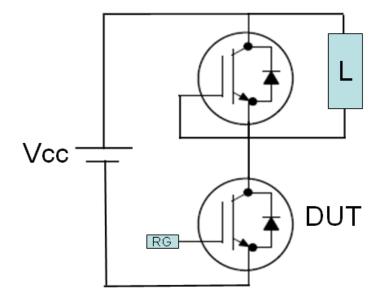


Figure 21. Test Circuit for Switching Characteristics

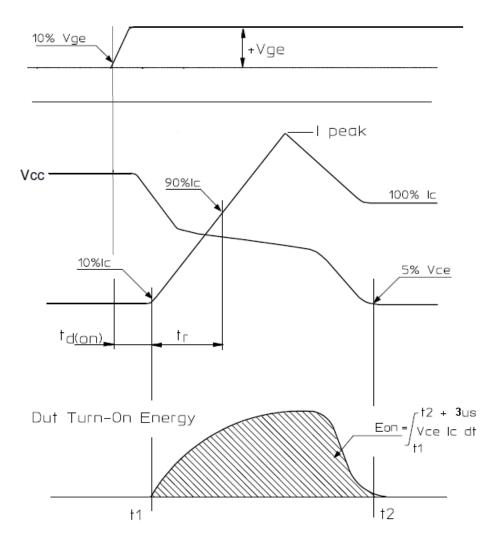


Figure 22. Definition of Turn On Waveform

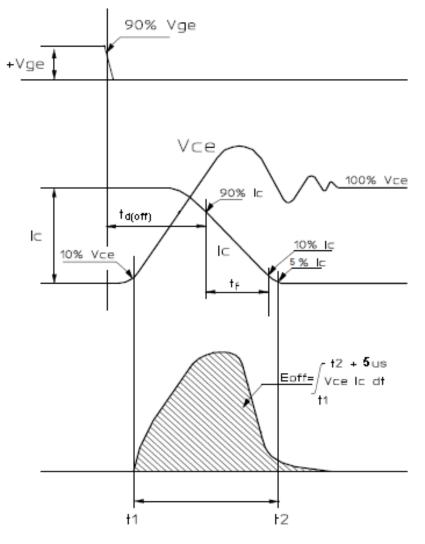
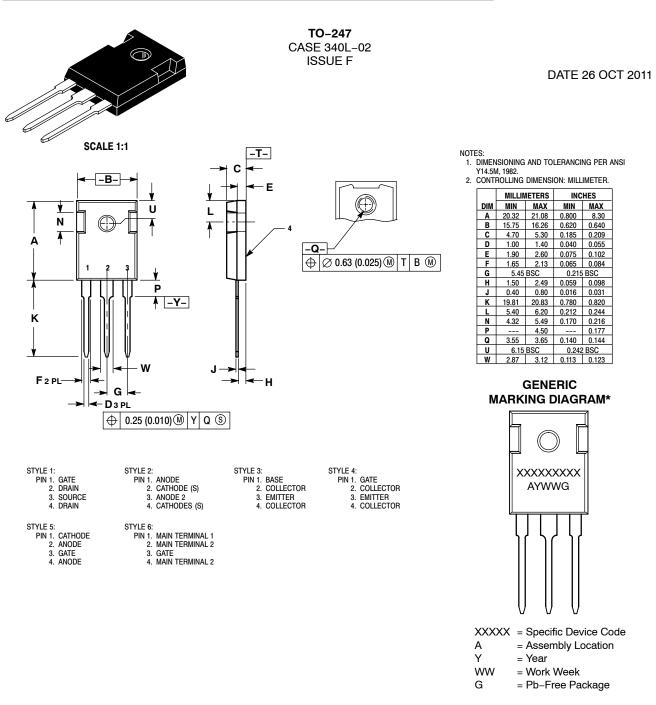


Figure 23. Definition of Turn Off Waveform

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

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D	CHANGE OF OWNERSHIP FROM MOTOROLA TO ON SEMICONDUCTOR. DIM A WAS 20.80–21.46/0.819–0.845. DIM K WAS 19.81–20.32/0.780–0.800. UPDATED STYLE 1, ADDED STYLES 2, 3, & 4. REQ. BY L. HAYES.	25 AUG 2000
E	DIM E MINIMUM WAS 2.20/0.087. DIM K MINIMUM WAS 20.06/0.790. ADDED GENERIC MARKING DIAGRAM. REQ. BY S. ALLEN.	26 FEB 2010
F	ADDED STYLES 5 AND 6. REQ. BY J. PEREZ.	26 OCT 2011

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